

## CLAIMS

What is claimed is:

1. A touch panel, comprising:

- 5           an upper electrode plate;  
            a lower electrode plate being isolated electrically with said upper electrode plate;  
            a plurality of conductive lines connected electrically to said upper electrode plate and said lower electrode plate respectively; and  
10           a flexible printed circuit board (FPC) connected electrically to a terminal area of said touch panel, parts of said plurality of conductive lines located on said terminal area, wherein the folded parts of said FPC are overlapped over said touch panel.

- 15   2. The touch panel according to claim 1, further comprising a second FPC connected electrically to said touch panel.

3. The touch panel according to claim 1, wherein said plurality of conductive lines are the silver lines.

20

4. The touch panel according to claim 1, wherein said FPC is connected electrically to said touch panel by the bonding method.

5. The touch panel according to claim 1, further comprising a plurality

of dot spacers located in between said upper electrode plate and said lower electrode plate.

6. The touch panel according to claim 1, further comprising an  
5 adhesion layer disposed between said upper electrode plate and said lower electrode plate to adhere said upper and lower electrode plate.

7. The touch panel according to claim 1, wherein said upper electrode  
10 plate includes a first base substrate and an upper conductive layer formed beneath said first base substrate, and said lower electrode plate includes a second base substrate and a lower conductive layer formed on said second base substrate.

8. A touch panel comprising:  
15 a first electrode plate;  
a second electrode plate being isolated electrically with said first electrode plate;

a plurality of first conductive lines connected electrically to  
said first electrode plate and said second electrode plate respectively;

20 and

a flexible printed circuit board (FPC) connected electrically to a terminal area of said touch panel by the bonding method, a plurality of second conductive lines located on said FPC and connected electrically with said plurality of first conductive lines, wherein the folded parts of

said FPC are overlapped over said touch panel .

9. The touch panel according to claim 8, wherein said plurality of first conductive lines and said plurality of second conductive lines are the silver lines.

10. The touch panel according to claim 8, further comprising an adhesion layer disposed between said first electrode plate and said second electrode plate to adhere said first and second electrode plate.

11. The touch panel according to claim 8, wherein said first electrode plate includes a first base substrate and a first conductive layer formed on said first base substrate, and said second electrode plate includes a second base substrate and a second conductive layer formed on said second base substrate.

12. The touch panel according to claim 8, further comprising a second FPC connected electrically to said touch panel.

13. The touch panel according to claim 8, further comprising a plurality of dot spacers located in between said first electrode plate and said second electrode plate.